

LTCC

High Pass Filter

50Ω 4900 to 5850 MHz

Features

- Miniature size 0603
- Low Insertion Loss, 0.5 typ.
- Low cost
- Aqueous washable

Applications

- ISM Band
- WLAN
- Bluetooth
- Zigbee

HPJC-492R+



Generic photo used for illustration purposes only

CASE STYLE: JC0603C-7

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Available Tape and Reel at no extra cost

Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500, 1000, 3000

Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Pass Band	Insertion Loss ¹	—	0.5	0.9	dB
	VSWR	—	1.2	2.0	:1
Stop Band	Rejection Loss	—	25	—	dB
		2400 - 2500	25	36	—

1. Tested on Evaluation Board TB-1027+

Maximum Ratings

Operating Temperature	-40°C to 85°C
Storage Temperature ²	-40°C to 85°C
RF Power Input ³	2W at 25°C

2. Refer to product storage temperature after installation
Suggestion for T&R unused product storage condition:
+5 ~ +35 °C, Humidity 45~75%RH, 12 month Max
3. Derate linearly to 1W at 85°C.

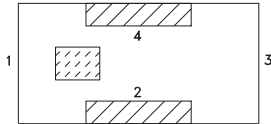
Typical Performance Data at 25°C

Frequency (GHz)	Insertion Loss (dB)	VSWR (:1)
0.50	29.47	627.15
1.00	24.45	604.00
1.50	23.27	1110.07
2.40	43.28	122.82
2.50	32.96	109.17
3.00	14.28	31.83
3.50	5.03	6.30
4.50	0.54	1.18
4.90	0.44	1.12
5.00	0.43	1.12
5.50	0.40	1.22
5.90	0.44	1.36
6.00	0.44	1.39
7.00	0.40	1.18
8.00	0.54	1.31

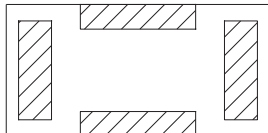
Block Diagram



Top View

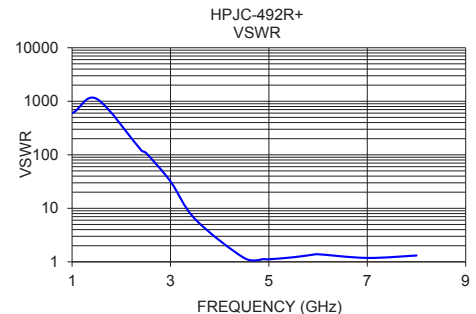
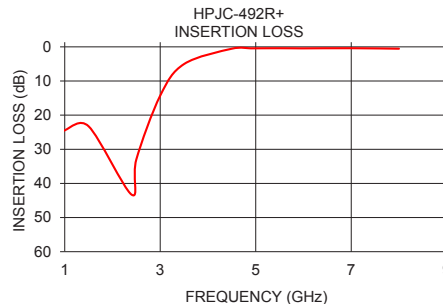


Bottom View



Pad Connections

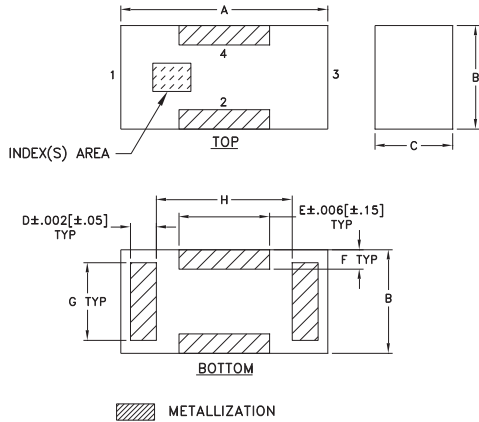
Input	1
Output	3
Ground	2,4



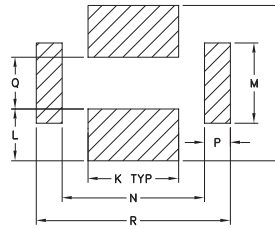
High Pass Filter

HPJC-492R+

Outline Drawing

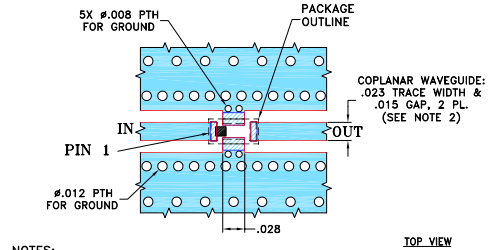


PCB Land Pattern



Suggested Layout,
Tolerance to be within .002

Evaluation Board MCL P/N: TB-1027+ Suggested PCB Layout (PL-565)



NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
 2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR FR4 WITH DIELECTRIC THICKNESS $.008 \pm .001$; COPPER: 1/2 OZ. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 3. LAYER 3 AND LAYER 4 OF THE PCB ARE CONTINUOUS GROUND PLANES.
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Outline Dimensions (inch mm)

A	B	C	D	E	F	G	H	J
.063	.032	.024	.008	.028	.006	.024	.041	.047
1.60	0.81	0.61	0.20	0.71	0.15	0.6096	1.04	1.19
K	L	M	N	P	Q	R	wt	
.028	.016	.024	.043	.008	.016	0.059	grams	
0.71	0.41	0.61	1.09	0.20	0.41	1.50	.005	

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

